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Renesas Electronics Corporation

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H8/300H Tiny Series

Conversion from Five-Digit BCD to Two-Byte Hexadecimal (BCD)

Introduction

Converts the three-byte five-digit BCD (binary coded decimal) number set in general registers to a two-byte hexadecimal number, and places the result in another general register.

Target Device

H8/300H Tiny Series

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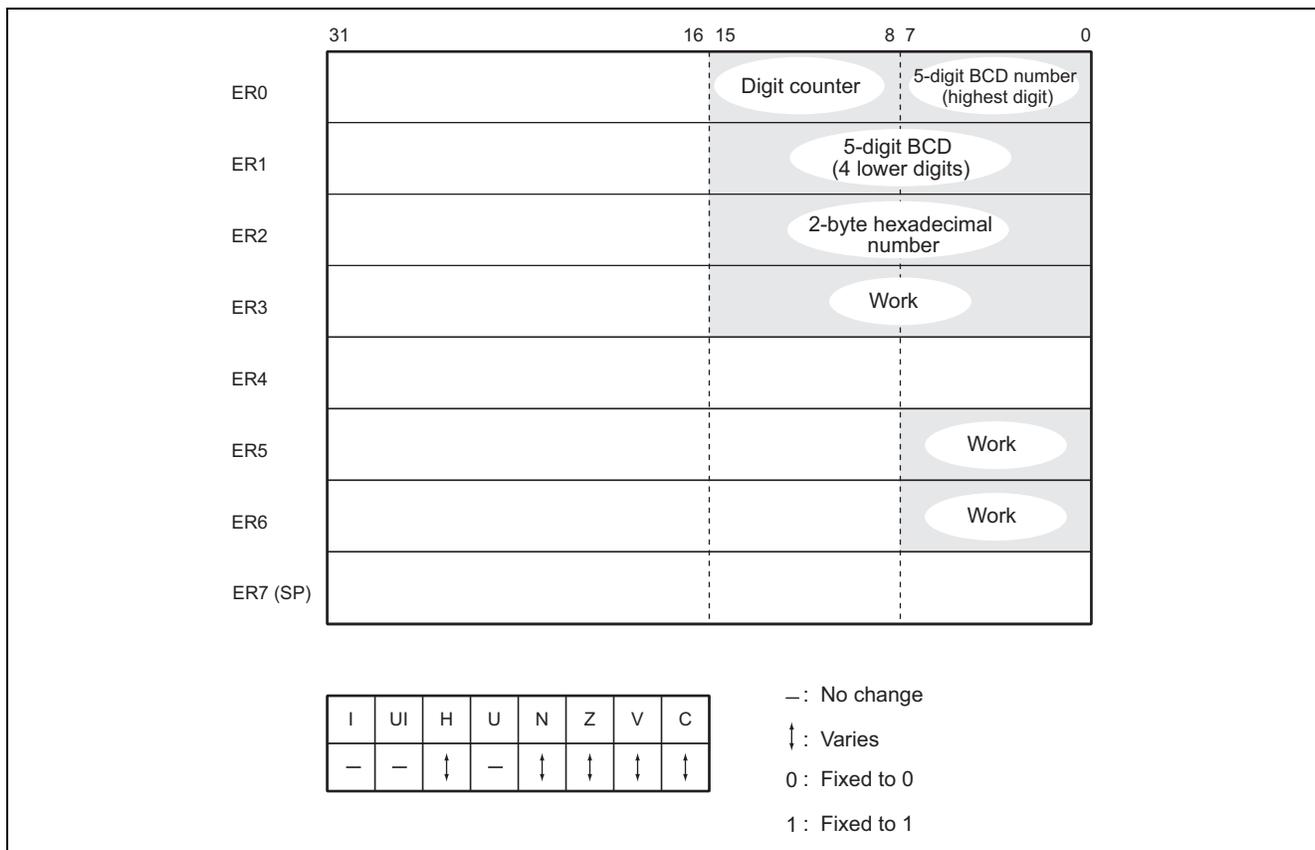
1. Function

1. Converts a three-byte five-digit BCD (binary coded decimal) number in general registers to two-byte hexadecimal, and places the result in another general register.
2. Data operations are entirely on the general registers.
3. The maximum acceptable five-digit BCD number is D'65535.

2. Arguments

Contents	Storage Location	Data Length (Bytes)
Input		
5-digit BCD number (highest-order digit)	R0L	1
5-digit BCD number (4 lower-order digits)	R1	2
Output		
2-byte hexadecimal number	R2	2

3. Changes to Internal Registers and Flags



4. Programming Specifications

Program memory (bytes)
64
Data memory (bytes)
0
Stack (bytes)
2
Number of cycles
210
Re-entrant
Yes
Relocatable
Yes
Interrupts during execution
Yes

5. Description

5.1 Description of Functions

1. The arguments are as follows.

R0L: Set the highest-order digit (byte) of the five-digit BCD number as part of the input argument.

R1: Set the lower-order four digits (two bytes) of the BCD number as part of the input argument.

R2: The two-byte hexadecimal number is set here as the output argument.

Figure 1 shows the format of the input and output arguments.

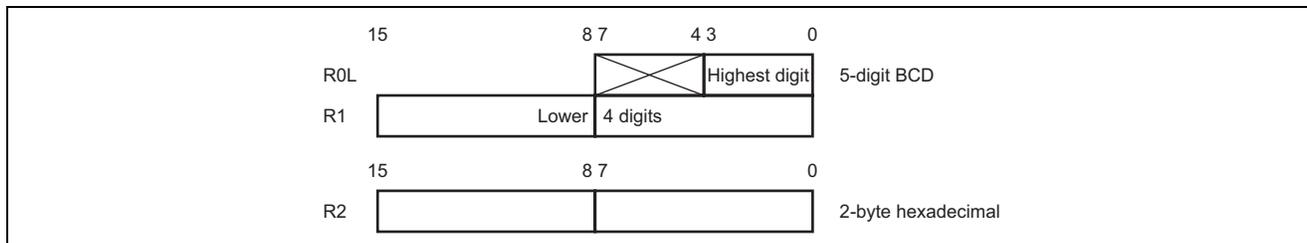


Figure 1 Input and Output Arguments

2. Figure 2 illustrates the execution of the BCD subroutine. When the input argument is set as shown below, the subroutine sets the corresponding two-byte hexadecimal number in R2.

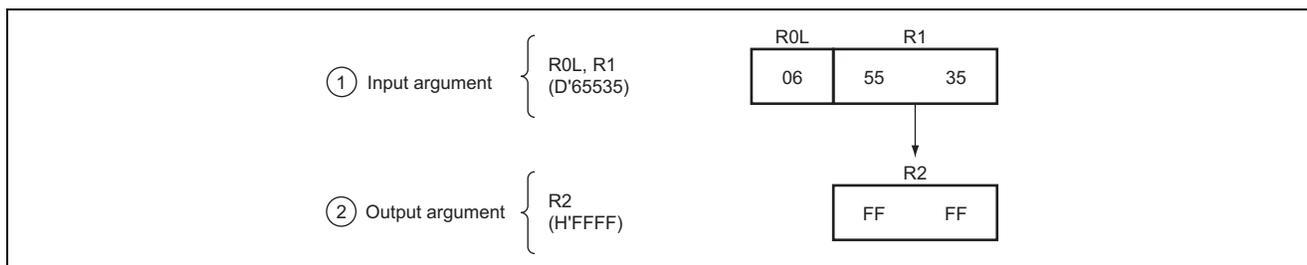


Figure 2 Example of BCD Execution

5.2 Usage Notes

1. The values of bits 4 to 7 in R0L, which hold the highest-order digit of the five-digit BCD number, are not converted and are cleared to "0", regardless of their initial value, by the execution of this subroutine.
2. D'65535 is thus the highest possible five-digit BCD number.
3. Any higher-order digits of the five-digit BCD number that are not used must be explicitly set to "0". If this is not done, the correct result might not be obtained because undefined data in the higher-order digits is included in the operation.

5.3 Description of Data Memory

No data memory is used by BCD.

5.4 Example of Usage

After setting the five-digit BCD number as an input argument, call the BCD subroutine.

```

WORK1  . RES. B 3      ..... Reservation of the data memory area for setting of the 5-digit BCD number (3 bytes) by the
                                user program.
WORK2  . RES. B 2      ..... Reservation of the data memory area where the 2-byte hexadecimal number will be set for
                                the user program.
      .
      .
MOV. B @WORK1, R0L ..... Sets, as the input argument, the 5-digit BCD number specified by the user program.

MOV. B @WORK1+1, R1H

MOV. B @WORK1+2, R1L

JSR   @BCD ..... Subroutine call of BCD.

MOV. B R2H, @WORK2 ..... Transfers the 2-byte hexadecimal number set as the output argument to the data memory area
                                of the user program.
MOV. B R2L, @WORK2+1
      .
      .
      .
    
```

5.5 Principles of Operation

1. The BCD subroutine has two sequences of processing.
 - 1) Extraction of the individual digits from the five-digit BCD number.
 - 2) Conversion of the extracted data to hexadecimal in four-bit units.
2. The processing of one digit (four bits) of input data is described below with reference to figure 3.

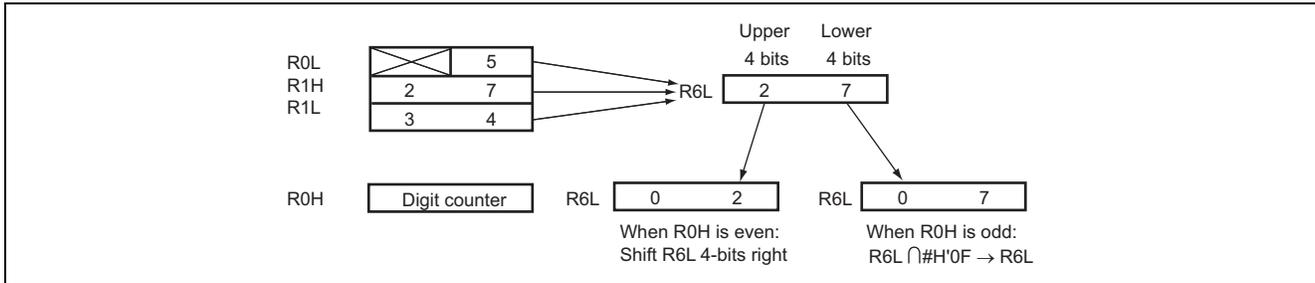


Figure 3 Dividing One Byte of Data in a General Register in Two

The BCD subroutine

- 1) sets H'04 in R0H to count the execution of processing for five digits;
- 2) transfers the current byte from the five-digit BCD number (R0L, R1H, R1L) to R6L in sequence from the highest-order byte;
- 3) decrements R0H.
- 4) selects the higher-order or lower-order four bits of that byte on the basis of whether the counter value is even or odd:
 - when R0H is odd, takes the logical AND of R6L and H'0F to extract the four lower-order bits,
 - when R0H is even, shifts R6L four bits to the right to extract the four higher-order bits; and

3. BCD-to-hexadecimal conversion is carried out in the following way.

1) A four-digit BCD number given as $D_3D_2D_1D_0$ may be expressed as shown below.

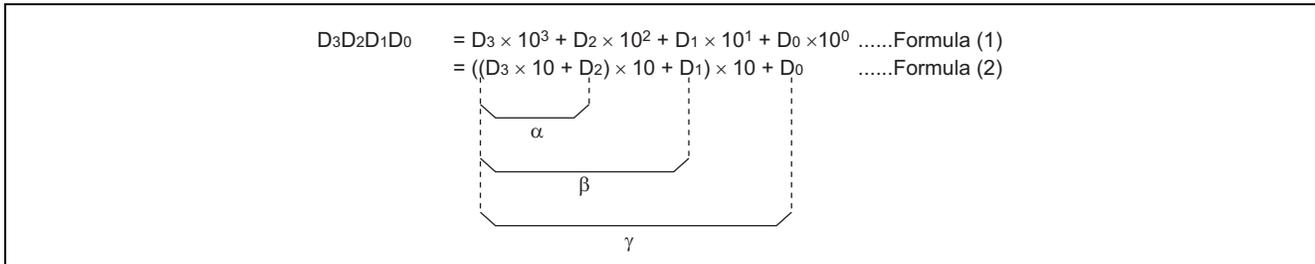


Figure 4 Concept of the Four-Digit BCD Number $D_3D_2D_1D_0$

2) Formula (2) in the above figure tells us that a four-digit BCD number can be converted to hexadecimal by finding

$$\alpha = D_3 \times 10 + D_2; \text{ and then calculating } \beta = \alpha \times 10 + D_1 \text{ and } \gamma = \beta \times 10 + D_0.$$

3) $D_3 \times 10$ can be calculated by the following formulae (3) and (4).

$$D_3 \times 10 = D_3 \times (2 + 8) \quad \text{Formula (3)}$$

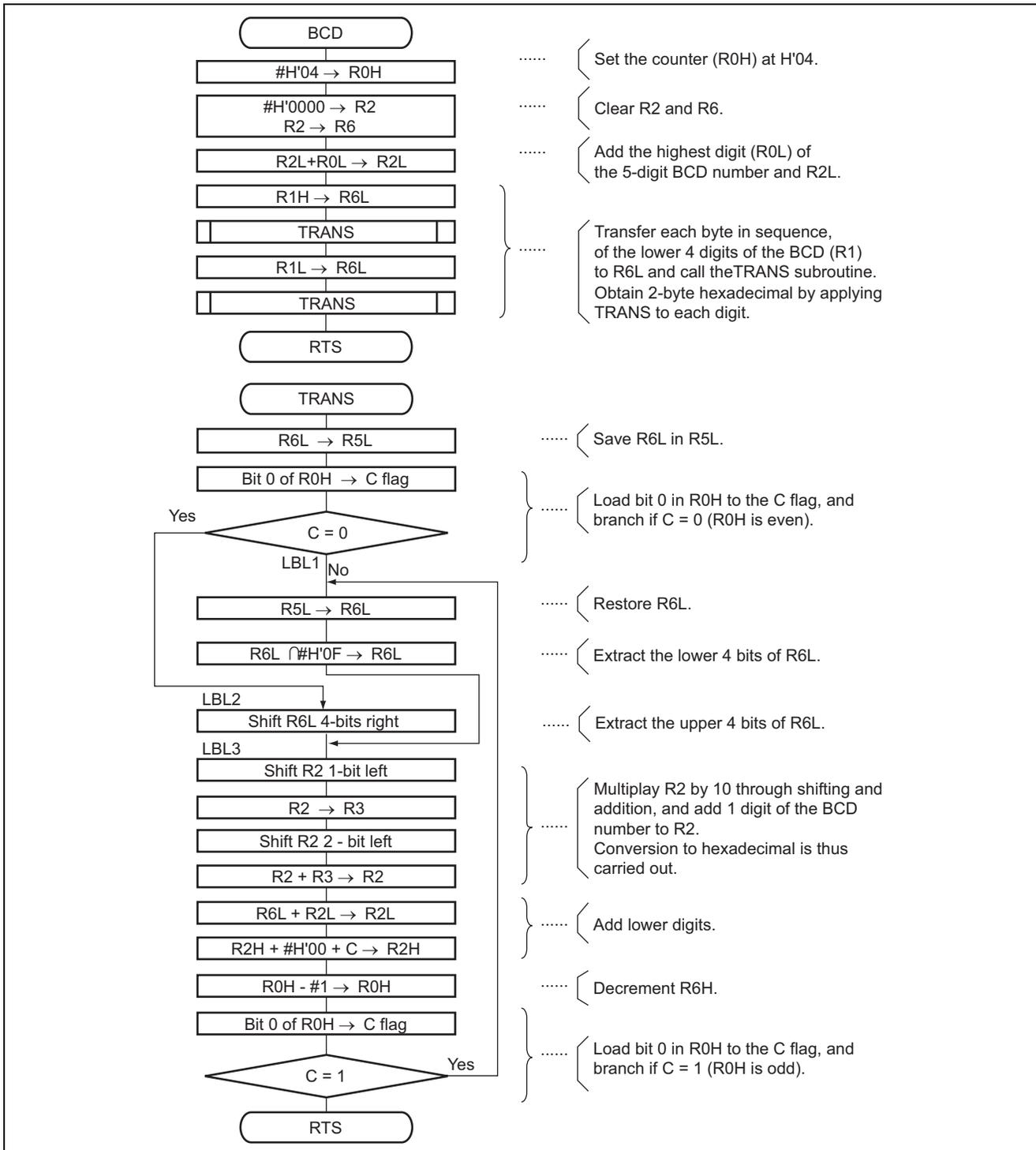
$$= D_3 \times 2 \times (1 + 2^2) \quad \text{Formula (4)}$$

4) In the BCD subroutine, formula (4) is implemented by using R2 and R3 in the following steps.

- a. D_3 is set in R2 and then shifted 1-bit left.
- b. R2 is transferred to R3 and then shifted two-bits left.
- c. R3 is added to R2.

4. The two-byte hexadecimal number is obtained by repeating the above steps, 2 and 3, five times.

6. Flowchart



7. Program Listing

```

1          1          ;*****
2          2          ;*
3          3          ;*      NAME : CHANGE 5 DIGIT BCD
4          4          ;*      TO 2 BYTE HEXADECIMAL
5          5          ;*
6          6          ;*****
7          7          ;*
8          8          ;*      ENTRY: R0L      (HIGHEST DIGIT (BCD))
9          9          ;*      R1      (LOWER 4 DIGITS (BCD))
10         10         ;*
11        11         ;*      RETURN: R2      (2 BYTE HEXADECIMAL)
12        12         ;*
13        13         ;*****
14        14         ;
15        15         .CPU      300HN
16        16         .SECTION  BCD_code, CODE, ALIGN=2
17        17         .EXPORT  BCD
18        18         ;
19        19         BCD      .EQU      $      ;Entry point
20        20         MOV.B    #'04,R0H    ;Set bit counter
21        21         MOV.W    #'0000,R2   ;Clear R2
22        22         MOV.W    R2,R6      ;Clear R6
23        23         ;
24        24         ADD.B    R0L,R2L    ;R2L + R0L -> R2L
25        25         MOV.B    R1H,R6L    ;R1H -> R6L
26        26         BSR      TRANS
27        27         MOV.B    R1L,R6L    ;R1L -> R6L
28        28         BSR      TRANS
29        29         RTS
30        30         ;
31        31         ;-----
32        32         ;
33        33         TRANS
34        34         MOV.B    R6L,R5L    ;R6L -> R5L
35        35         BLD      #0,R0H     ;Load bit 0 of R0H
36        36         BCC      LBL2      ;Branch if C=0
37        37         LBL1
38        38         MOV.B    R5L,R6L    ;R5L -> R6L
39        39         AND.B    #'0F,R6L   ;Clear bit 7-4 of R6L
40        40         BRA      LBL3      ;Branch always
41        41         LBL2
42        42         SHLR.B   R6L        ;Shift R6L 4 bits left
43        43         SHLR.B   R6L
44        44         SHLR.B   R6L
45        45         SHLR.B   R6L
46        46         LBL3
47        47         SHLL.B   R2L        ;Shift hexadecimal 1 bit left
48        48         ROTXL.B  R2H
49        49         MOV.W    R2,R3     ;R2 -> R3
50        50         SHLL.B   R2L        ;Shift hexadecimal 2 bit left
51        51         ROTXL.B  R2H
52        52         SHLL.B   R2L

```

```
53 0034 1202          53          ROTXL.B   R2H
54 0036 0932          54          ADD.W    R3,R2      ;R3 + R2 -> R2
55 0038 08EA          55          ADD.B    R6L,R2L
56 003A 9200          56          ADDX.B   #0,R2H
57 003C 1A00          57          DEC.B    R0H        ;Decrement bit counter
58 003E 7700          58          BLD     #0,R0H     ;Load bit 0 of R0H
59 0040 45D8          59          BCS     LBL1       ;Branch if C=1
60 0042 5470          60          RTS
61                    61          ;
62                    62          .END
*****TOTAL ERRORS    0
*****TOTAL WARNINGS  0
```

Revision Record

Rev.	Date	Description	
		Page	Summary
2.00	Feb.28.06	—	Format has been changed from Hitachi version to Renesas version.

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